Schottky barrier diode

RB521S-40

**Applications**
Rectifying small power

**Features**
1) Ultra small mold type. (EMD2)
2) Low $V_F$
3) High reliability

**Construction**
Silicon epitaxial planar

**Taping dimensions** (Unit : mm)
- $0.90 \pm 0.05$ x $0.6 \pm 0.1$
- $40 \times 0\times 0.05$
- $20 \times 0\times 0.05$
- $5.5 \times 0\times 0.05$
- $0.75 \times 0\times 0.05$
- $0.9 \times 0\times 0.05$
- $0.7 \times 0\times 0.05$
- $3.5 \times 0\times 0.05$
- $1.75 \times 0\times 0.05$
- $8.0 \times 0\times 0.05$
- $0.2 \times 0$

**Absolute maximum ratings** (Ta=25°C)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Reverse voltage (repetitive peak)</td>
<td>VRM</td>
<td>45</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Reverse voltage (DC)</td>
<td>$V_R$</td>
<td>40</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>Average retified forward current</td>
<td>$I_o$</td>
<td>200</td>
<td></td>
<td></td>
<td>mA</td>
</tr>
<tr>
<td>Forward current surge peak (60Hz/1cyc)</td>
<td>$I_{FSM}$</td>
<td>4</td>
<td></td>
<td></td>
<td>A</td>
</tr>
<tr>
<td>Junction temperature</td>
<td>$T_j$</td>
<td>150</td>
<td></td>
<td></td>
<td>°C</td>
</tr>
<tr>
<td>Storage temperature</td>
<td>$T_{stg}$</td>
<td>-55 to +150</td>
<td></td>
<td></td>
<td>°C</td>
</tr>
</tbody>
</table>

**Electrical characteristic** (Ta=25°C)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Forward voltage</td>
<td>$V_F$</td>
<td>0.16</td>
<td>0.26</td>
<td>0.30</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.31</td>
<td>0.395</td>
<td>0.45</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>0.41</td>
<td>0.495</td>
<td>0.54</td>
<td>V</td>
</tr>
<tr>
<td>Reverse current</td>
<td>$I_R$</td>
<td>3.5</td>
<td></td>
<td>20</td>
<td>µA</td>
</tr>
<tr>
<td>ESD break down voltage</td>
<td>ESD</td>
<td>10</td>
<td></td>
<td></td>
<td>kV</td>
</tr>
</tbody>
</table>

Conditions:
- $I_F=10mA$
- $I_F=100mA$
- $I_F=200mA$
- $V_R=10V$
- $V_R=40V$
- $C=100pF$, $R=1.5k\Omega$, forward and reverse : 1time
● Electrical characteristic curves

- **Forward Voltage (Vf):**
  - Curve showing Vf vs. If for different temperatures (Ta).
  - Values vary from 470 to 520 mV.

- **Reverse Voltage (Vr):**
  - Curve showing Vr vs. Ir for different temperatures (Ta).
  - Values vary from 0 to 100 mV.

- **Capacitance Between Terminals (Ct):**
  - Curves showing Ct vs. frequency for different temperatures (Ta).
  - Values range from 20 to 80 pF.

- **Peak Surge Forward Current (Ifsm):**
  - Curves showing Ifsm vs. time for different temperatures (Ta).
  - Values range from 1 to 100 mA.

- **Reverse Power Dissipation (Pwr):**
  - Curves showing Pwr vs. frequency for different temperatures (Ta).
  - Values range from 0.01 to 0.5 W.

- **Thermal Impedance (Rth):**
  - Curves showing Rth vs. temperature for different powers (P).
  - Values range from 0.1 to 1 W/°C.

- **Average Rectified Forward Current (Io):**
  - Curves showing Io vs. time for different frequencies (f).
  - Values range from 0.01 to 0.5 A.

- **Average Rectified Forward Power (P):**
  - Curves showing P vs. frequency for different temperatures (Ta).
  - Values range from 0.01 to 0.5 W.

- **Reverse Voltage (Vr):**
  - Curves showing Vr vs. frequency for different temperatures (Ta).
  - Values range from 0.01 to 0.5 W.

- **Ave. Rect. Int. Current (Ia):**
  - Curves showing Ia vs. frequency for different temperatures (Ta).
  - Values range from 0.01 to 0.5 A.

- **Voltage Dispersion Map (VF):**
  - Chart showing VF vs. frequency for different temperatures (Ta).

- **Current Dispersion Map (Ifsm):**
  - Chart showing Ifsm vs. frequency for different temperatures (Ta).

- **Time (t):**
  - Curves showing t vs. frequency for different temperatures (Ta).
  - Values range from 0.01 to 100 s.

- **DC Bias:**
  - DC bias of 1 mA is applied to the device.

- **Mounted on epoxy board:**
  - Indicates the device is mounted on an epoxy board to test its characteristics.

- **Sin(θ):**
  - Shows the sine function for different angles (θ).

- **D=1/2:**
  - Represents the duty cycle of 1/2 for the current waveform.
AMBIENT TEMPERATURE : Ta(℃)
Derating Curve"(Io-Ta)

CASE TEMPERATURE : Tc(℃)
Derating Curve"(Io-Tc)
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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM’s Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

<table>
<thead>
<tr>
<th>JAPAN</th>
<th>USA</th>
<th>EU</th>
<th>CHINA</th>
</tr>
</thead>
<tbody>
<tr>
<td>CLASS III</td>
<td>CLASS III</td>
<td>CLASS II b</td>
<td>CLASS III</td>
</tr>
</tbody>
</table>

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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[a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
[b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
[c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
[d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
[e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
[f] Sealing or coating our Products with resin or other coating materials
[g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
[h] Use of the Products in places subject to dew condensation

4. The Products are not subject to radiation-proof design.

5. Please verify and confirm characteristics of the final or mounted products in using the Products.

6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.

8. Confirm that operation temperature is within the specified range described in the product specification.

9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.

2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification
Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.

2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic
This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of Ionizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation
1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
   [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
   [b] the temperature or humidity exceeds those recommended by ROHM
   [c] the Products are exposed to direct sunshine or condensation
   [d] the Products are exposed to high Electrostatic

2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.

3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.

4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label
QR code printed on ROHM Products label is for ROHM’s internal use only.

Precaution for Disposition
When disposing Products please dispose them properly using an authorized industry waste company.

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